

RD07MVS1

RoHS Compliance, Silicon MOSFET Power Transistor, 175MHz, 520MHz, 7W, 7.2V

DESCRIPTION

RD07MVS1 is a MOS FET type transistor specifically designed for VHF/UHF RF power amplifiers applications.

FEATURES

High power gain:

Pout>7W, Gp>10dB@Vdd=7.2V,f=520MHz

High Efficiency: 60%typ. (175MHz) High Efficiency: 55%typ. (520MHz) Integrated gate protection diode.

APPLICATION

For output stage of high power amplifiers in VHF/UHF band mobile radio sets.

ROHS COMPLIANT

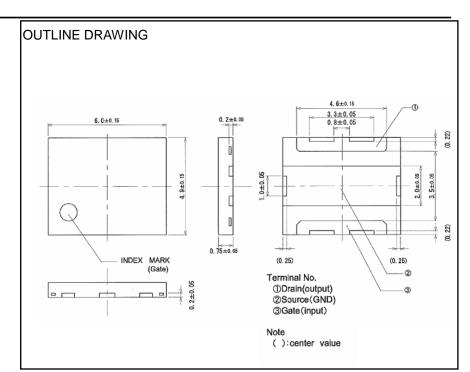
RD07MVS1-501, T512, T514 is EU RoHS compliant.

ABSOLUTE MAXIMUM RATINGS

(Tc=25°C UNLESS OTHERWISE NOTED)

SYMBOL	PARAMETER	CONDITIONS	RATINGS	UNIT
VDSS	Drain to source voltage	Vgs=0V	30	V
VGSS	Gate to source voltage	Vds=0V	-5 / +10	V
Pch *	Channel dissipation	Tc=25°C	50	W
Pin	Input Power	Zg=Zl=50Ω	1.5	W
ID	Drain Current	-	3	Α
Tch	Junction Temperature	-	150	°C
Tstg	Storage temperature	-	-40 to +125	°C
Rth j-c	Thermal resistance	Junction to case	2.5	°C/W

Note: Above parameters are guaranteed independently.



^{*} Theoretical value in case of mounted on infinite heat sink.

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ELECTRICAL CHARACTERISTICS (Tc=25°C, UNLESS OTHERWISE NOTED)

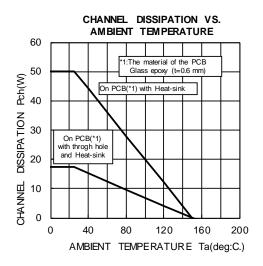
SYMBOL	PARAMETER	CONDITIONS	LIMITS			UNIT
	PARAMETER	CONDITIONS	MIN	TYP	MAX.	
IDSS	Zero gate voltage drain current	VDS=17V, VGS=0V	-	-	200	uA
Igss	Gate to source leak current	VGS=10V, VDS=0V	-	-	1	uA
VTH	Gate threshold Voltage	VDS=12V, IDS=1mA	1.4	2.0	2.4	V
Pout1	Output power	f=175MHz , VDD=7.2V	7	8	-	W
ηD1	Drain efficiency	Pin=0.3W,ldq=700mA	55	60	-	%
Pout2	Output power	f=520MHz , VDD=7.2V	7	8	-	W
ηD2	Drain efficiency	Pin=0.7W,ldq=750mA	50	55	-	%
	Load VSWR tolerance	VDD=9.2V,Po=7W(Pin Control)	No destroy			
VSWRT1		f=175MHz,ldq=700mA,Zg=50Ω				-
		Load VSWR=20:1(All Phase)				
VSWRT2	Load VSWR tolerance	VDD=9.2V,Po=7W(Pin Control)				
		f=520MHz,ldq=750mA,Zg=50Ω	N	-		
		Load VSWR=20:1(All Phase)				

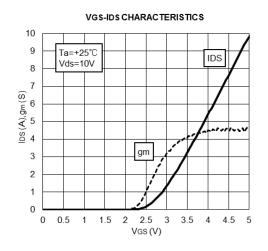
Note: Above parameters, ratings, limits and conditions are subject to change.

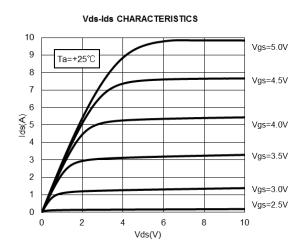
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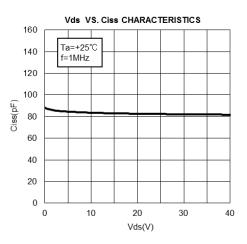
TYPICAL CHARACTERISTICS

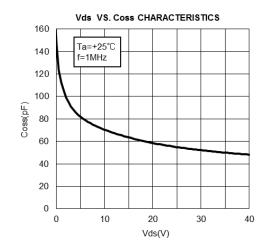
(These are only typical curves and devices are not necessarily guaranteed at these curves.)

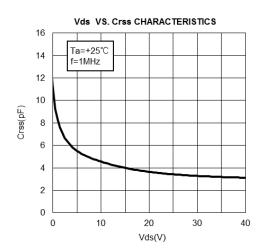








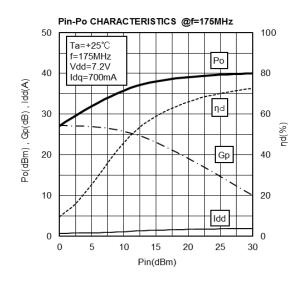


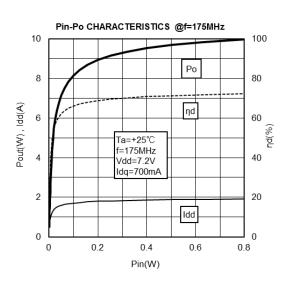


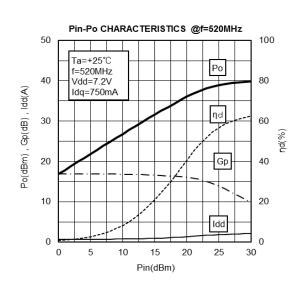
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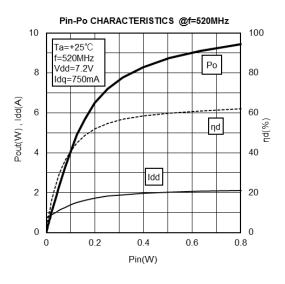
TYPICAL CHARACTERISTICS

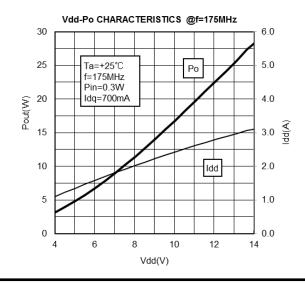
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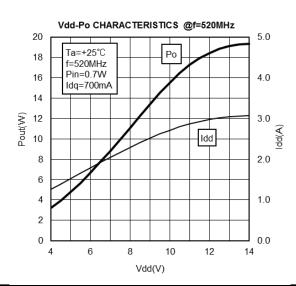






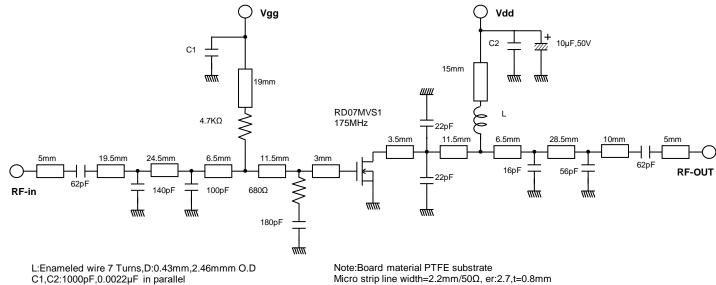






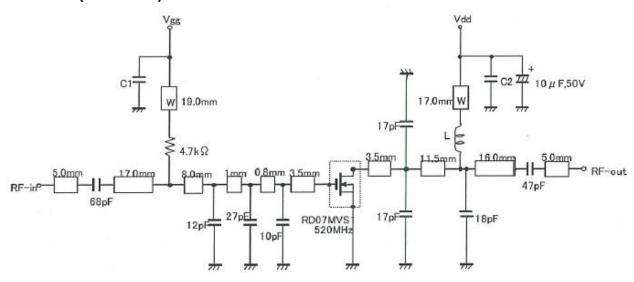
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TEST CIRCUIT(f=175MHz)



W:line width=1.0mm

TEST CIRCUIT(f=520MHz)



Note: Board material-PTFE substrate, Micro strip line width=2.2mm/50 Ω , ϵ r=2.7, t=0.8mm

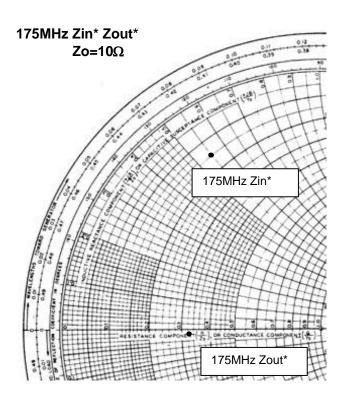
W : Line width=1.0mm

L : 6turns, D=0.43mm, ϕ =2.46mm(the outside diameter) , enameled wire

C1, C2: Parallel of 1000pF & 0.022 μ F

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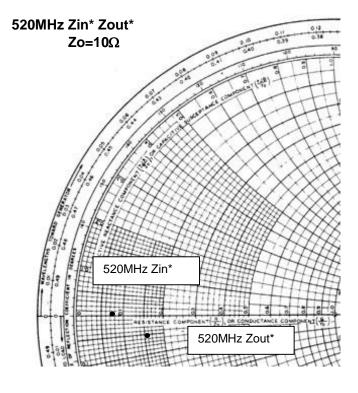
INPUT/OUTPUT IMPEDANCE VS. FREQUENCY CHARACTERISTICS



Vdd=7.2V, Idq=700mA(Vgg adj.),Pin=0.28W

Zin*=1.55+j5.53 Zout*=3.24-j0.26

Zin*: Complex conjugate of input impedance Zout*: Complex conjugate of output impedance



Vdd=7.2V, Idq=750mA(Vgg adj.),Pin=0.7W

Zin*=0.76+j0.06 Zout*=1.61-j0.52

Zin*: Complex conjugate of input impedance Zout*: Complex conjugate of input impedance

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RD07MVS1 S-PARAMETER DATA (@Vdd=7.2V, Id=750mA)

Freq.	Freq. S11		S21		S12		S22	
(MHz)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)	(mag)	(ang)
100	0.856	-171.6	8.712	79.1	0.012	-9.7	0.821	-172.9
150	0.864	-173.4	5.643	70.9	0.012	-16.8	0.835	-173.4
175	0.870	-173.8	4.746	67.3	0.012	-20.1	0.844	-173.5
200	0.876	-174.2	4.065	63.8	0.011	-23.0	0.853	-173.6
250	0.888	-175.0	3.096	57.4	0.011	-28.6	0.870	-173.7
300	0.900	-175.5	2.445	51.8	0.010	-33.2	0.885	-174.0
350	0.912	-176.2	1.981	46.6	0.009	-37.4	0.899	-174.5
400	0.921	-176.9	1.635	41.9	0.008	-40.8	0.910	-175.0
450	0.930	-177.5	1.368	37.8	0.007	-43.6	0.918	-175.5
500	0.937	-178.2	1.158	34.1	0.007	-46.0	0.924	-176.0
520	0.939	-178.4	1.087	32.8	0.006	-46.8	0.925	-176.1
550	0.943	-178.9	0.991	31.0	0.006	-47.9	0.928	-176.3
600	0.948	-179.5	0.859	28.3	0.005	-49.2	0.934	-176.6
650	0.953	179.8	0.752	25.7	0.005	-49.8	0.941	-176.9
700	0.956	179.3	0.666	23.2	0.004	-50.6	0.947	-177.4
750	0.959	178.6	0.592	21.0	0.004	-50.6	0.954	-177.9
800	0.962	178.0	0.530	18.9	0.003	-50.3	0.957	-178.4
850	0.964	177.4	0.477	16.8	0.003	-48.6	0.961	-179.0
900	0.966	176.8	0.432	15.0	0.002	-47.2	0.963	-179.6
950	0.968	176.1	0.393	13.3	0.002	-43.0	0.966	179.9
1000	0.969	175.6	0.359	11.7	0.002	-38.1	0.967	179.4
1050	0.970	174.9	0.328	10.0	0.001	-28.9	0.969	178.9
1100	0.970	174.3	0.302	8.4	0.001	-14.9	0.970	178.4

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ATTENTION:

- 1. High Temperature; This product might have a heat generation while operation, Please take notice that have a possibility to receive a burn to touch the operating product directly or touch the product until cold after switch off. At the near the product, do not place the combustible material that have possibilities to arise the fire.
- 2.Generation of High Frequency Power; This product generate a high frequency power. Please take notice that do not leakage the unnecessary electric wave and use this products without cause damage for human and property per normal operation.
- 3.Before use; Before use the product, Please design the equipment in consideration of the risk for human and electric wave obstacle for equipment.

PRECAUTIONS FOR THE USE OF MITSUBISHI SILICON RF POWER DEVICES:

- 1. The specifications of mention are not guarantee values in this data sheet. Please confirm additional details regarding operation of these products from the formal specification sheet. For copies of the formal specification sheets, please contact one of our sales offices.
- 2.RA series products (RF power amplifier modules) and RD series products (RF power transistors) are designed for consumer mobile communication terminals and were not specifically designed for use in other applications. In particular, while these products are highly reliable for their designed purpose, they are not manufactured under a quality assurance testing protocol that is sufficient to guarantee the level of reliability typically deemed necessary for critical communications elements and In the application, which is base station applications and fixed station applications that operate with long term continuous transmission and a higher on-off frequency during transmitting, please consider the derating, the redundancy system, appropriate setting of the maintain period and others as needed. For the reliability report which is described about predicted operating life time of Mitsubishi Silicon RF Products, please contact Mitsubishi Electric Corporation or an authorized Mitsubishi Semiconductor product distributor.
- 3. RD series products use MOSFET semiconductor technology. They are sensitive to ESD voltage therefore appropriate ESD precautions are required.
- 4. In the case of use in below than recommended frequency, there is possibility to occur that the device is deteriorated or destroyed due to the RF-swing exceed the breakdown voltage.
- 5. In order to maximize reliability of the equipment, it is better to keep the devices temperature low. It is recommended to utilize a sufficient sized heat-sink in conjunction with other cooling methods as needed (fan, etc.) to keep the channel temperature for RD series products lower than 120deg/C(in case of Tchmax=150deg/C) ,140deg/C(in case of Tchmax=175deg/C) under standard conditions.
- 6. Do not use the device at the exceeded the maximum rating condition. In case of plastic molded devices, the exceeded maximum rating condition may cause blowout, smoldering or catch fire of the molding resin due to extreme short current flow between the drain and the source of the device. These results causes in fire or injury.
- 7. For specific precautions regarding assembly of these products into the equipment, please refer to the supplementary items in the specification sheet.
- 8. Warranty for the product is void if the products protective cap (lid) is removed or if the product is modified in any way from it's original form.
- 9. For additional "Safety first" in your circuit design and notes regarding the materials, please refer the last page of this data sheet.

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- 10. Please avoid use in the place where water or organic solvents can adhere directly to the product and the environments with the possibility of caustic gas, dust, salinity, etc. Reliability could be markedly decreased and also there is a possibility failures could result causing a serious accident. Likewise, there is a possibility of causing a serious accident if used in an explosive gas environment. Please allow for adequate safety margin in your designs.
- 11. Please refer to the additional precautions in the formal specification sheet.

Keep safety first in your circuit designs!

Mitsubishi Electric Corporation puts the maximum effort into making semiconductor products better and more reliable, but there is always the possibility that trouble may occur with them. Trouble with semiconductors may lead to personal injury, fire or property damage. Remember to give due consideration to safety when making your circuit designs, with appropriate measures such as (i) placement of substitutive, auxiliary circuits, (ii) use of non-flammable material or (iii) prevention against any malfunction or mishap.

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Publication Date : Jun. 2019